

Harvatek Surface Mount LEDs Approval Sheet V1081TX Series

Official Product	HT Part No. V1081TX Series		
Tentative Product	*****	*****	
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DISCLAIMER

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Life Support Policy

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specification

Item	Specification	Material	Quantity
Luminous Intensity(Iv)	Cool White:1440~2010 mcd @20mA/ T _S = 25°C ;Tolerance: ± 10%		
Chromaticity Coordinate	As page 7 & 8 @20mA/ T _S = 25°C ;Tolerance: ± 0.005		
Vf	Cool White:2.8~3.5 V (0.1V/Bin) @20mA/ T _S = 25°C ;Tolerance: ± 0.05V		
Vf(ESD)	>500uA @ Vr=0.8V		
Resin	Yellow	Silicon Resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard		
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, CIE and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

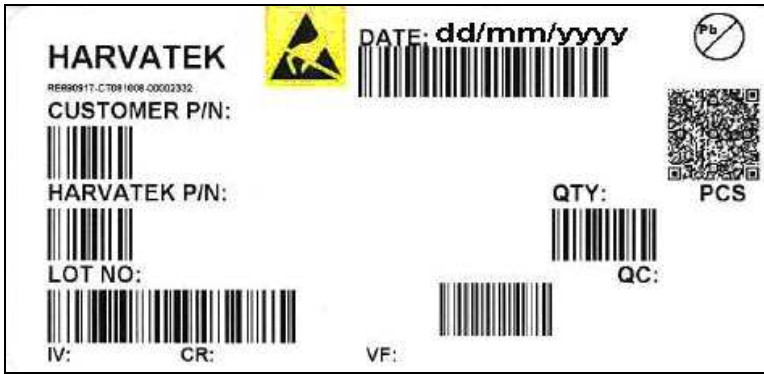


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

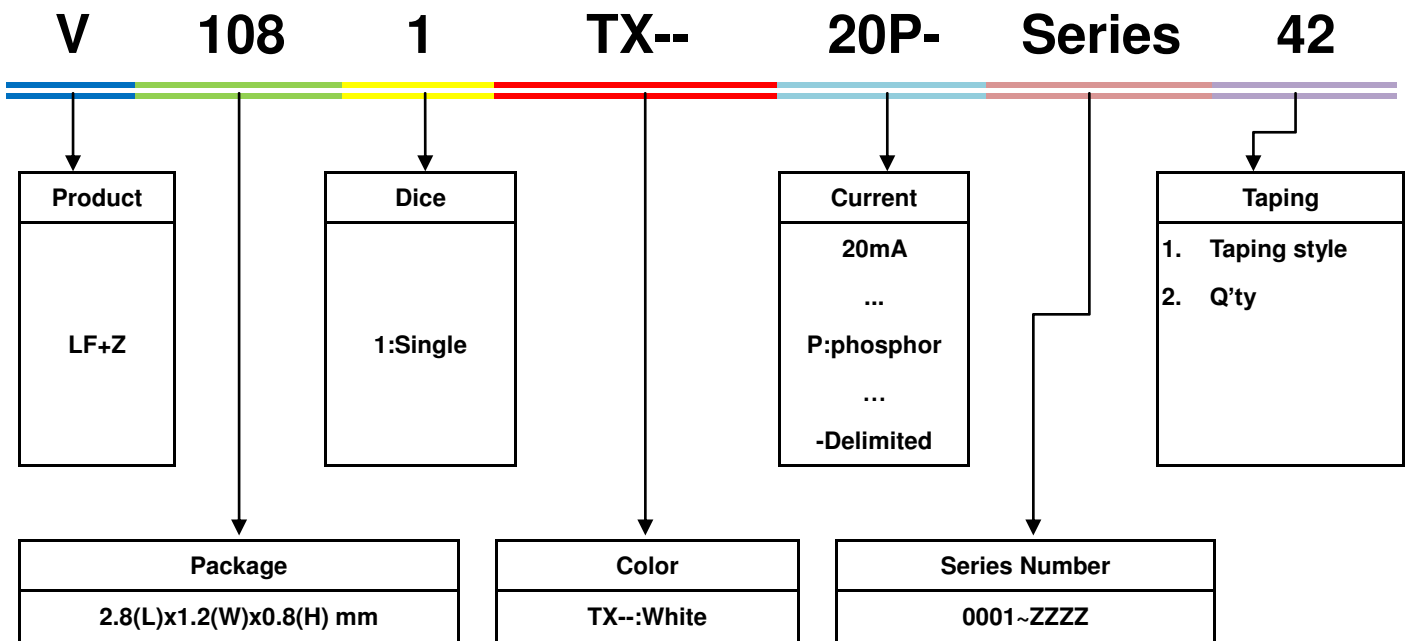
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications:



Harvatek P/N



Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A 2011-B 2012-C 2013-D . .	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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Specifications Range.

■ Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range
TX	Z31	1440 ~ 1520 mcd
	Z32	1520 ~ 1610 mcd
	Z41	1610 ~ 1700 mcd
	Z42	1700 ~ 1800 mcd
	Z51	1800 ~ 1900 mcd
	Z52	1900 ~ 2010 mcd

Note: It maintains a tolerance of $\pm 10\%$ on luminous intensity

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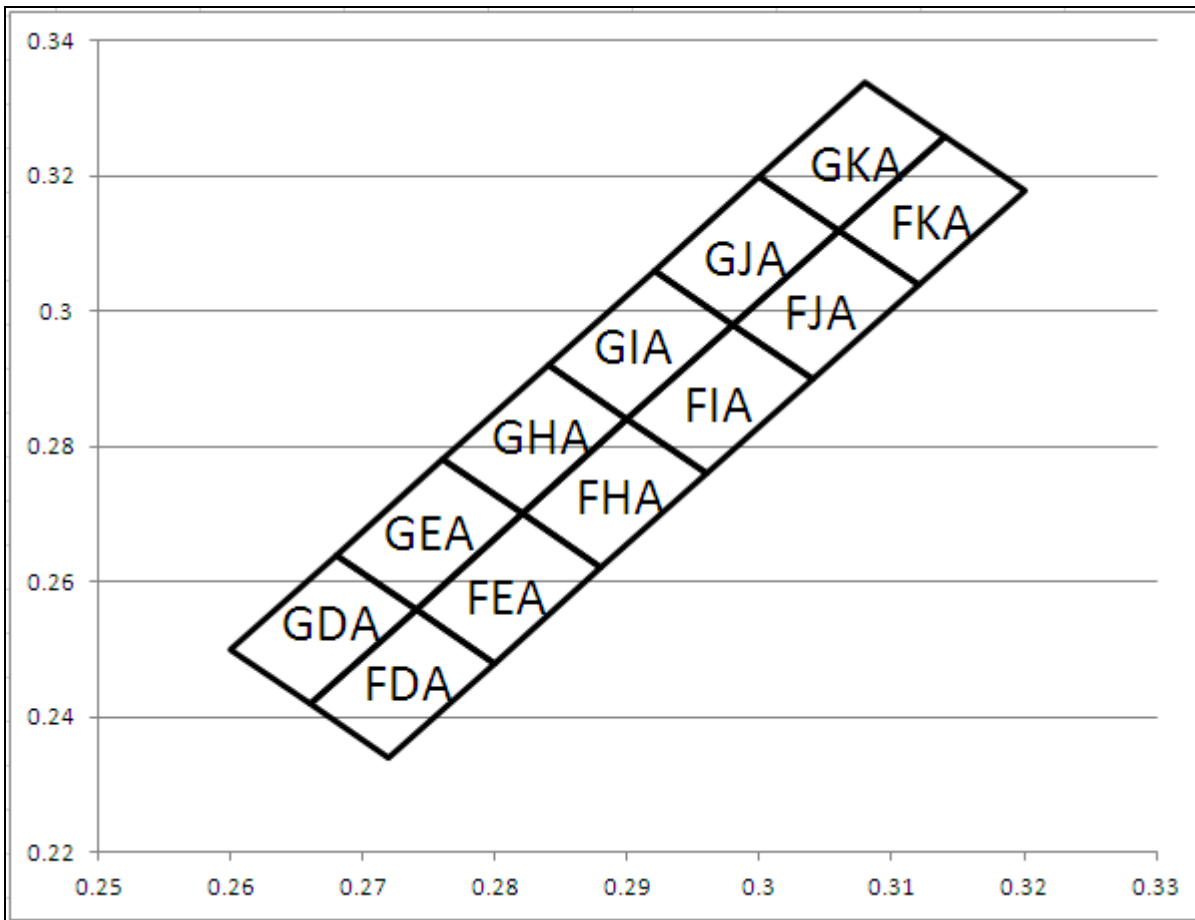
■ Color Bin:

	X	Y		X	Y
GDA	0.268	0.264	FDA	0.274	0.256
	0.26	0.25		0.266	0.242
	0.266	0.242		0.272	0.234
	0.274	0.256		0.28	0.248
	0.268	0.264		0.274	0.256
GEA	0.276	0.278	FEA	0.282	0.27
	0.268	0.264		0.274	0.256
	0.274	0.256		0.28	0.248
	0.282	0.27		0.288	0.262
	0.276	0.278		0.282	0.27
GHA	0.284	0.292	FHA	0.29	0.284
	0.276	0.278		0.282	0.27
	0.282	0.27		0.288	0.262
	0.29	0.284		0.296	0.276
	0.284	0.292		0.29	0.284
GIA	0.292	0.306	FIA	0.298	0.298
	0.284	0.292		0.29	0.284
	0.29	0.284		0.296	0.276
	0.298	0.298		0.304	0.29
	0.292	0.306		0.298	0.298
GJA	0.3	0.32	FJA	0.306	0.312
	0.292	0.306		0.298	0.298
	0.298	0.298		0.304	0.29
	0.306	0.312		0.312	0.304
	0.3	0.32		0.306	0.312
GKA	0.308	0.334	FKA	0.314	0.326
	0.3	0.32		0.306	0.312
	0.306	0.312		0.312	0.304
	0.314	0.326		0.32	0.318
	0.308	0.334		0.314	0.326

Note: It maintains a tolerance of x, y ± 0.005

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Chromaticity Coordinate:



■ Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
TX	H1	2.8-2.9
	H2	2.9-3.0
	H3	3.0-3.1
	H4	3.1-3.2
	J1	3.2-3.3
	J2	3.3-3.4
	J3	3.4~3.5

Note: It maintains a tolerance of $\pm 0.05V$ on forward voltage measurements

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Product Features

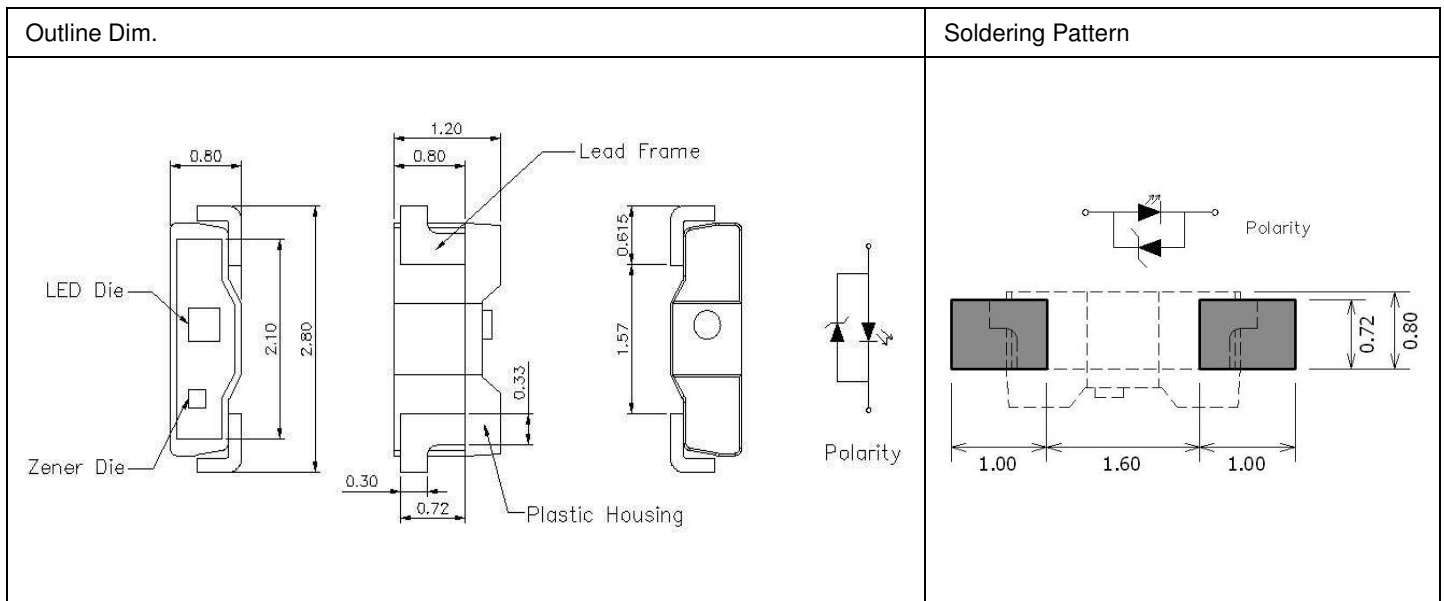
Electro-Optical Characteristics

(T_{Soldering} ,25 °C)

Series	Emitting Color	Material	V _F (V)		Chromaticity Coordinate x,y	I _v (mcd) Typical	Viewing Angle $2\theta \frac{1}{2}$
			typ	max			
V1081TX	Cool White	InGaN	3.2	3.5	x=0.2800 ,y=0.2600	1700	110

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)



Soldering terminals may shift in the x, y direction.

Absolute Maximum Ratings

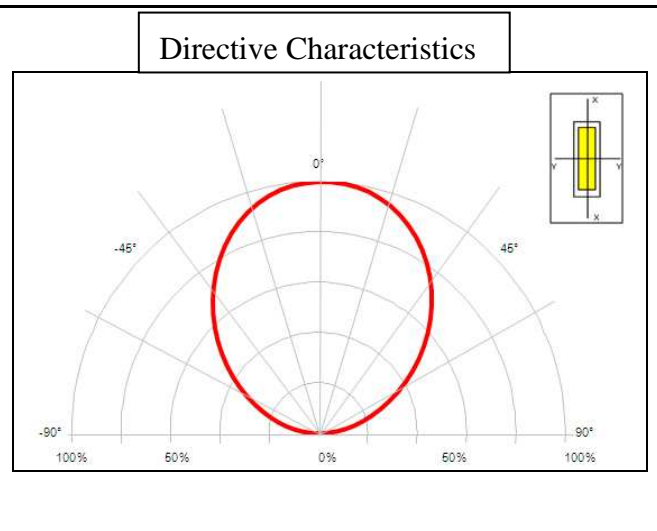
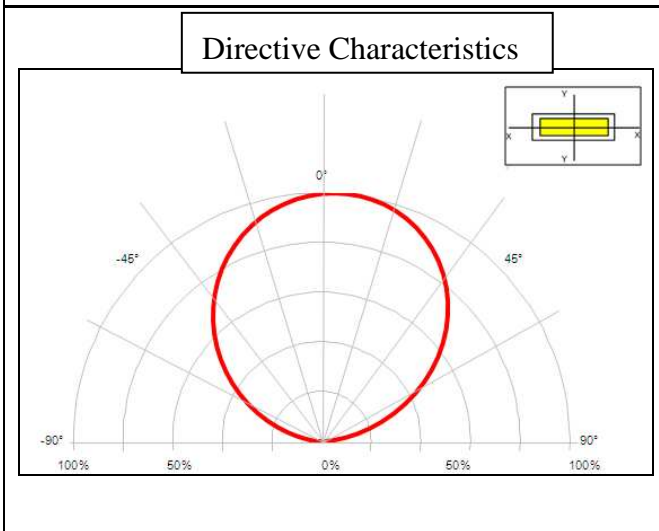
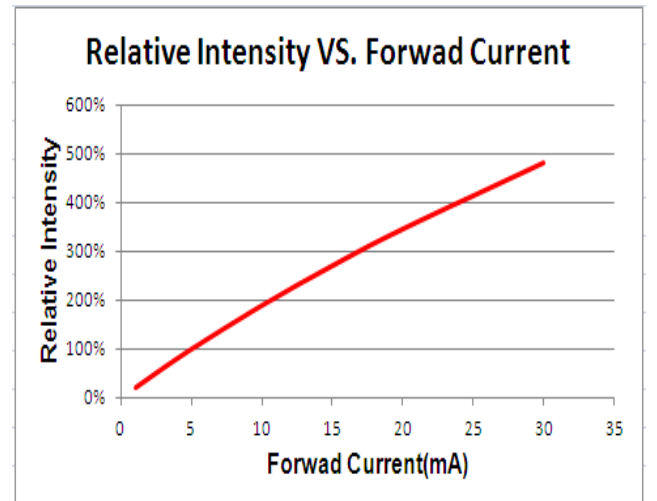
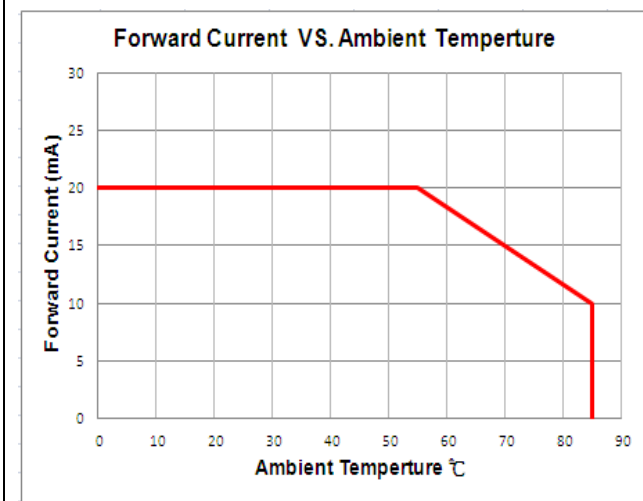
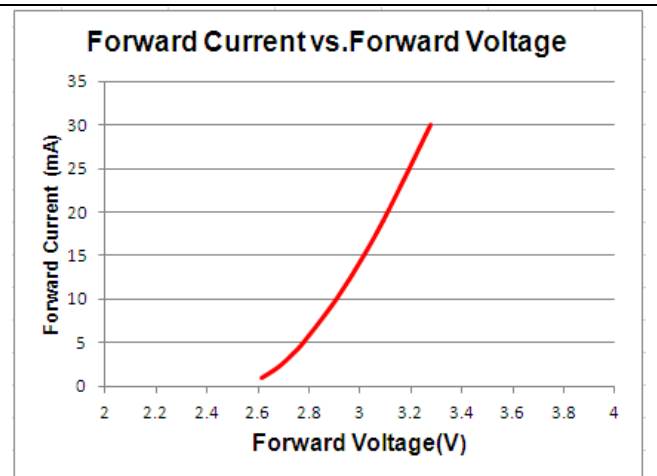
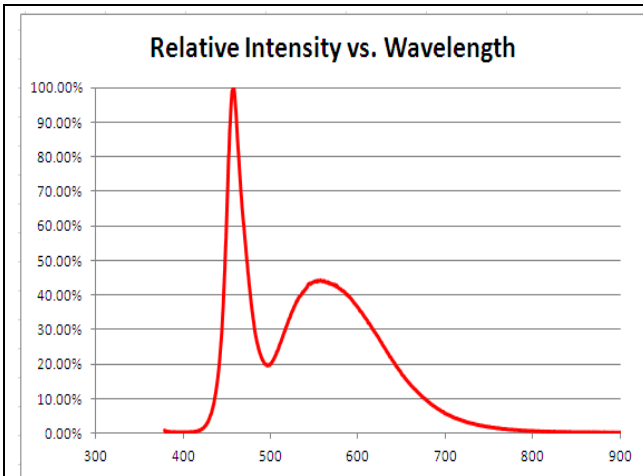
(T_{Soldering} ,25 °C)

Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (°C)
Color	Power Dissipation	Forward Current	Pulse Forward Current	Operating Temperature	Storage Temperature
TX	70	20	30	-40~+85	-40~+100

* Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

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Characteristics of V1081TX



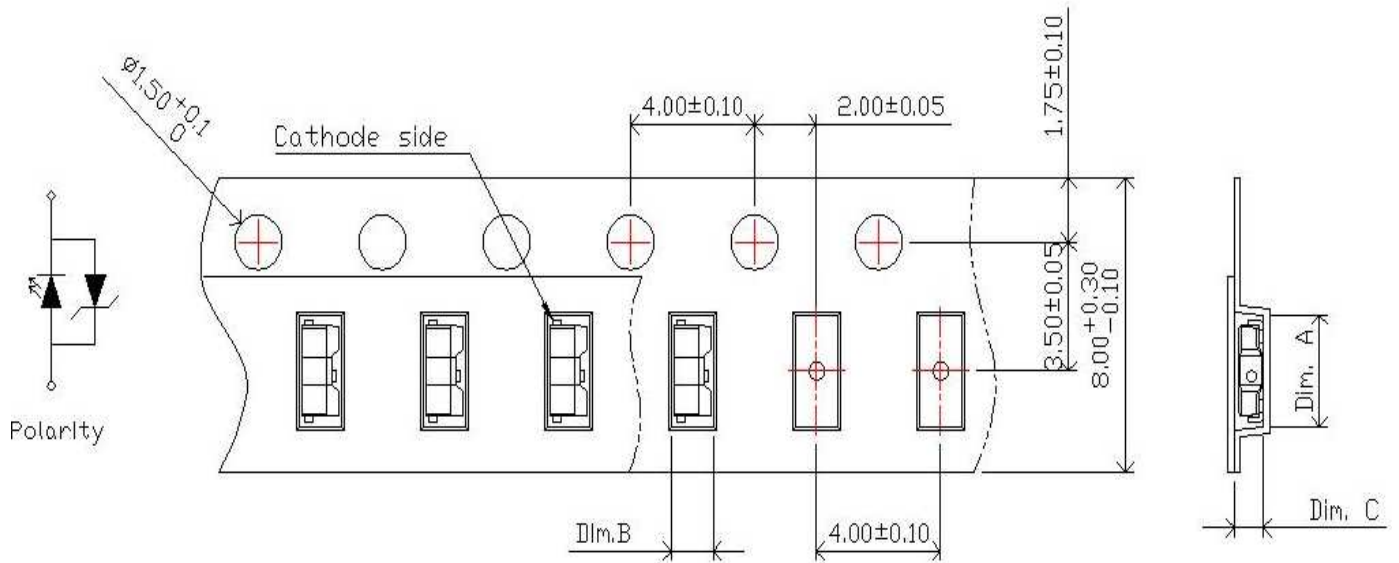
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Precaution for Use

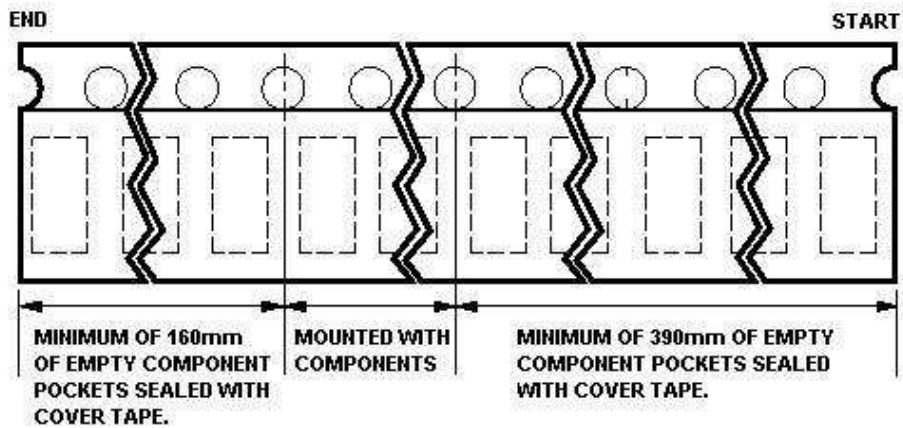
1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 72 hrs after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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Packaging Tape Dimension

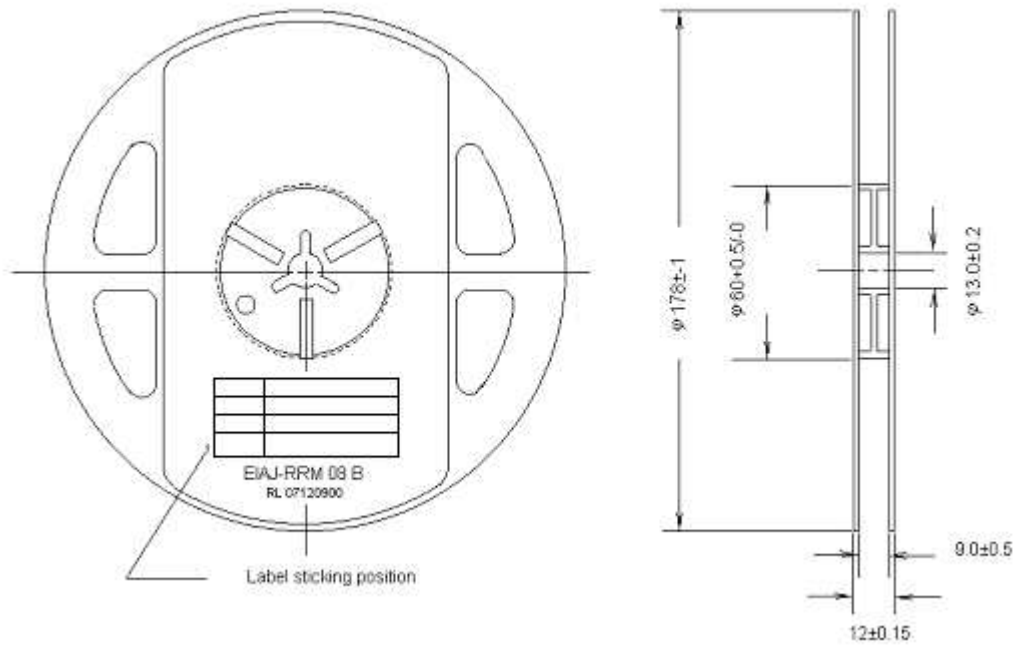


Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.05 ± 0.05	1.35 ± 0.05	0.95 ± 0.05	2K

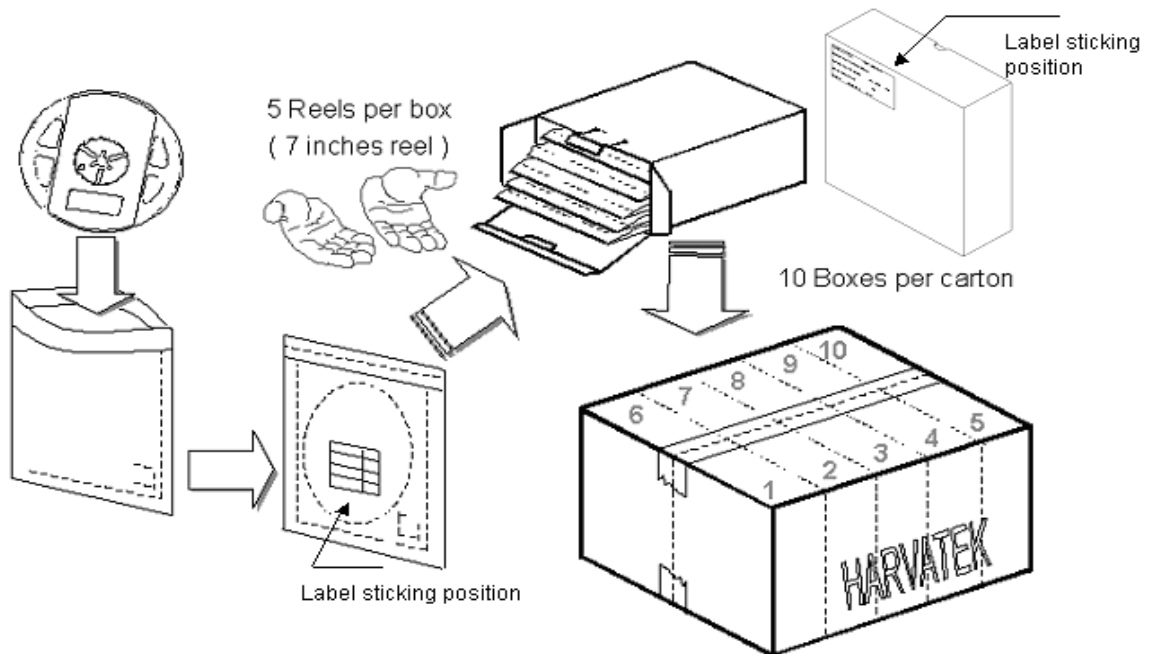


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Reel Dimension



Packing



5 boxes per carton is available depending on shipment quantity.

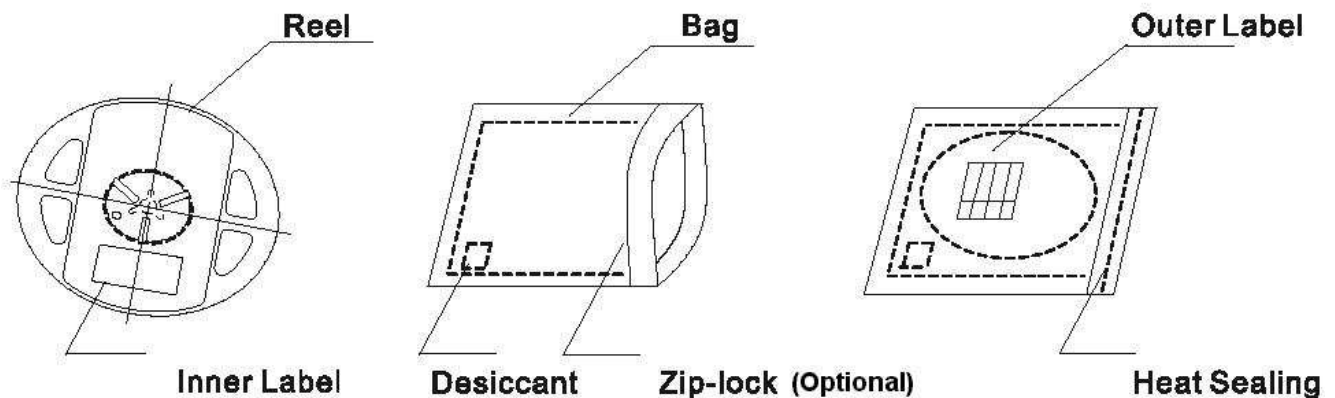
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

It's recommended to bake before soldering once the pack is unsealed open & re-sealed after 72 hours. The conditions are as followings:

1. $60 \pm 3^{\circ}\text{C} \times (12 \sim 24\text{hrs})$ and $< 5\% \text{ RH}$, taped reel type
2. $100 \pm 3^{\circ}\text{C} \times (45\text{min} \sim 1\text{hr})$, bulk type
3. $130 \pm 3^{\circ}\text{C} \times (15 \sim 30\text{min})$, bulk type

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

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Handling of Silicone Resin LEDs

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



Figure 1

In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.

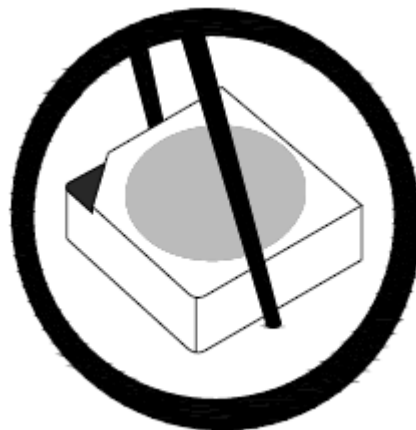


Figure 2

When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.

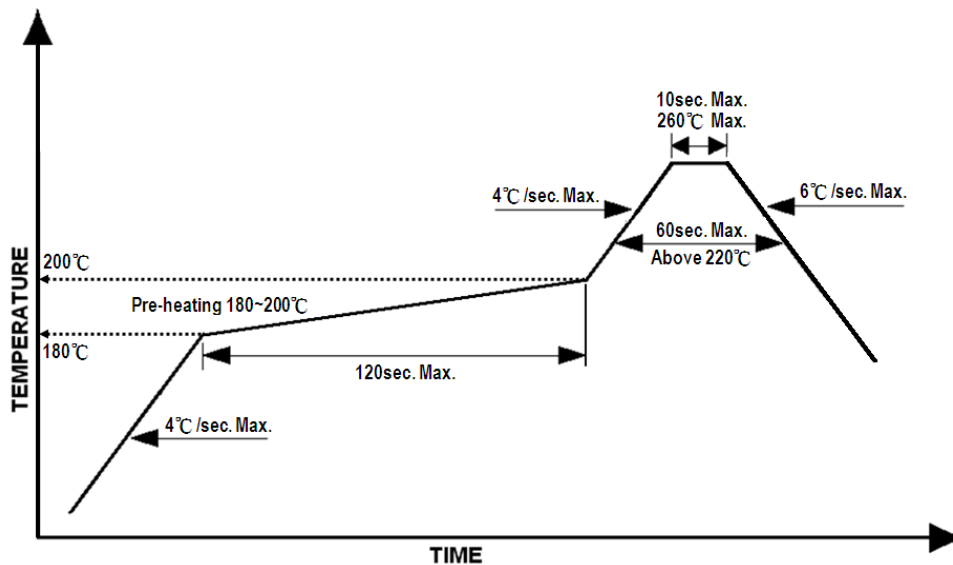
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 220 °C ,60sec
2. Peak temp.:260 °CMax.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never take next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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